TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type

# SSM3J113TU

### **High Speed Switching Applications**

• 2.0V drive

• Low on-resistance:  $R_{on} = 449 \text{m}\Omega \text{ (max) (@V_{GS} = -2.0 V)}$ 

 $R_{on}$  = 249m $\Omega$  (max) (@V<sub>GS</sub> = -2.5 V)

 $R_{on} = 169m\Omega \text{ (max) (@V_{GS} = -4.0 V)}$ 

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-Source voltage		$V_{DS}$	-20	V	
Gate-Source voltage		$V_{GSS}$	± 12	V	
Drain current	DC	I <sub>D</sub>	-1.7	A	
	Pulse	I <sub>DP</sub>	-3.4		
Drain power dissipation		P <sub>D (Note 1)</sub>	800	(mw\	
Drain power dissipation		P <sub>D (Note 2)</sub>	500		
Channel temperature		T <sub>ch</sub>	150	ပိ	
Storage temperature range		T <sub>stg</sub>	-55 to 150	∘C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on ceramic board.

(25.4 mm  $\times$  25.4 mm  $\times$  0.8 mm, Cu Pad: 645 mm2)

Note 2: Mounted on FR4 board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{Cu Pad: } 645 \text{ mm2})$ 

# 2.1±0.1 1.7±0.1 1.7±0.1 1.60te 2: Source 3: Drain UFM JEDEC — JEITA — TOSHIBA 2-2U1A

Weight: 6.6 mg (typ.)

### Electrical Characteristics (Ta = 25°C)

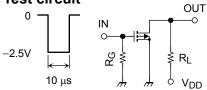
Charact	teristic	Symbol	Test Conditions	Min	Тур.	Max	Unit
Drain-Source breakdown voltage		V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0$	-20	_	_	V
		V (BR) DSX	$I_D = -1 \text{ mA}, V_{GS} = +12V$	-8	_		v
Drain cut-off currer	ıt	IDSS	$V_{DS} = -20 \text{ V}, V_{GS} = 0$	_	_	-1	μΑ
Gate leakage curre	ent	I <sub>GSS</sub>	$V_{GS} = \pm 12V, V_{DS} = 0$	_	_	±1	μΑ
Gate threshold volt	age	V <sub>th</sub>	$V_{DS} = -3 \text{ V}, I_D = -0.1 \text{ mA}$	-0.5	_	-1.1	V
Forward transfer ad	dmittance	Y <sub>fs</sub>	$V_{DS} = -3 \text{ V}, I_D = -0.65 \text{ A}$ (Note:	1.3	2.7		S
Drain-Source on-resistance			$I_D = -0.65 \text{ A}, V_{GS} = -4.0 \text{ V}$ (Note:	i) —	129	169	mΩ
		RDS (ON)	$I_D = -0.65 \text{ A}, V_{GS} = -2.5 \text{ V}$ (Note:	i) —	189	249	
			$I_D = -0.65 \text{ A}, V_{GS} = -2.0 \text{ V}$ (Note:	i) —	249	449	
Input capacitance		C <sub>iss</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	370	_	pF
Output capacitance	;	Coss	$V_{DS} = -10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	116		pF
Reverse transfer ca	apacitance	C <sub>rss</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	73		pF
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = -10 \text{ V}, I_D = -0.65 \text{ A},$ $V_{GS} = 0 \text{ to } -2.5 \text{ V}, R_G = 4.7 \Omega$	_	33	_	ns
	Turn-off time	t <sub>off</sub>		_	47	_	
Drain-Source forward voltage		V <sub>DSF</sub>	$I_D = 1.7 \text{ A}, V_{GS} = 0 \text{ V}$ (Note	3) —	0.77	1.2	V

Note3: Pulse test

Start of commercial production 2005-06

## **Switching Time Test Circuit**

(a) Test circuit



 $V_{DD} = -10 \text{ V}$ 

 $R_G = 4.7 \Omega$ 

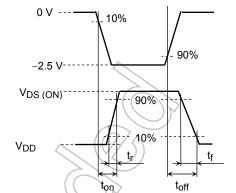
Duty ≤ 1%

 $V_{IN}\text{: }t_{f},\,t_{f}<5\text{ ns}$  Common Source

Ta = 25°C

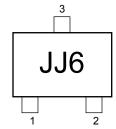
(b) V<sub>IN</sub>

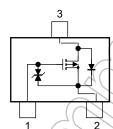
(c) Vout



# Marking

# **Equivalent Circuit (top view)**





#### **Precaution**

 $V_{th}$  can be expressed as the voltage between gate and source when the low operating current value is  $I_D$ =-0.1mA for this product. For normal switching operation,  $V_{GS}$  (on) requires a higher voltage than  $V_{th}$ , and  $V_{GS}$  (off) requires a lower voltage than  $V_{th}$ .

(The relationship can be established as follows: VGS (off) < Vth < VGS (on))

Take this into consideration when using the device.

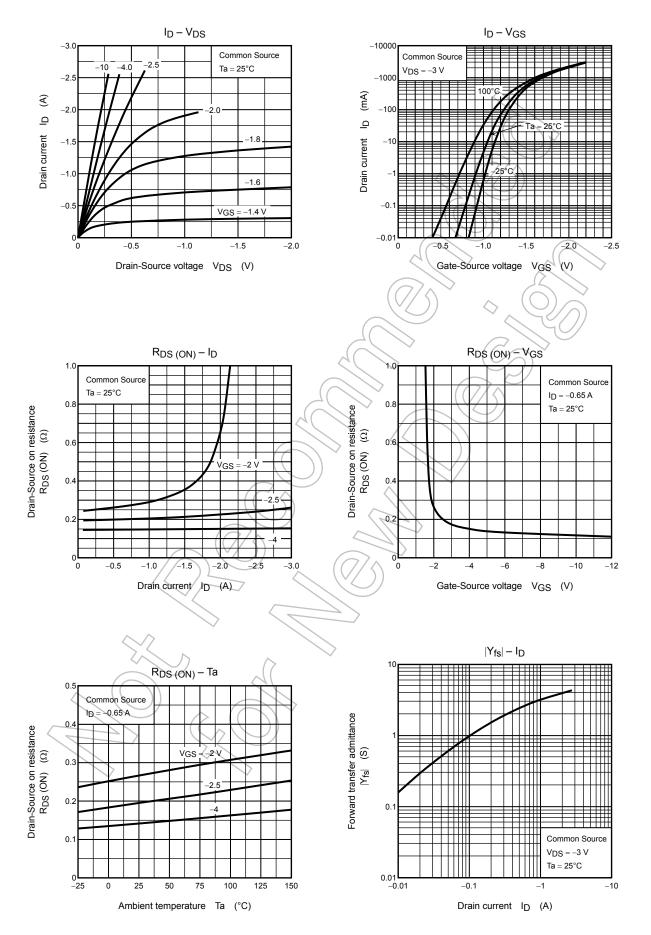
# **Handling Precaution**

When handling individual devices which are not yet mounted on a circuit board, be sure that the environment is protected against electrostatic discharge. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

2

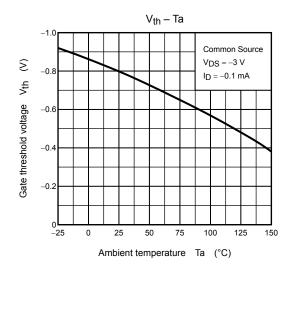


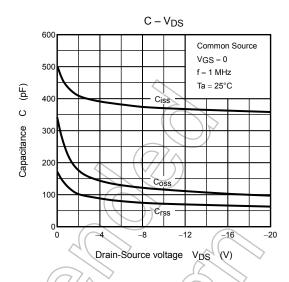
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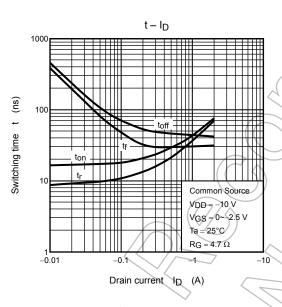


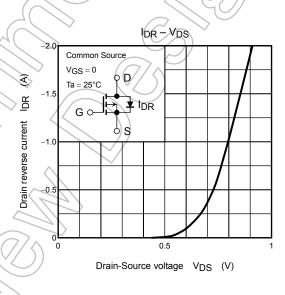
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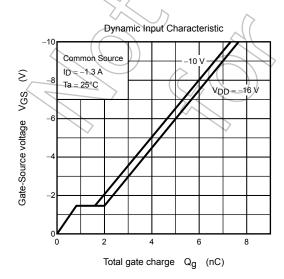
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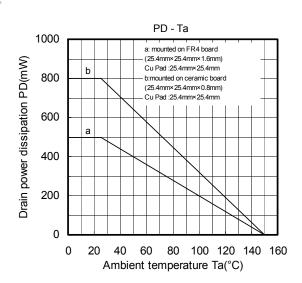


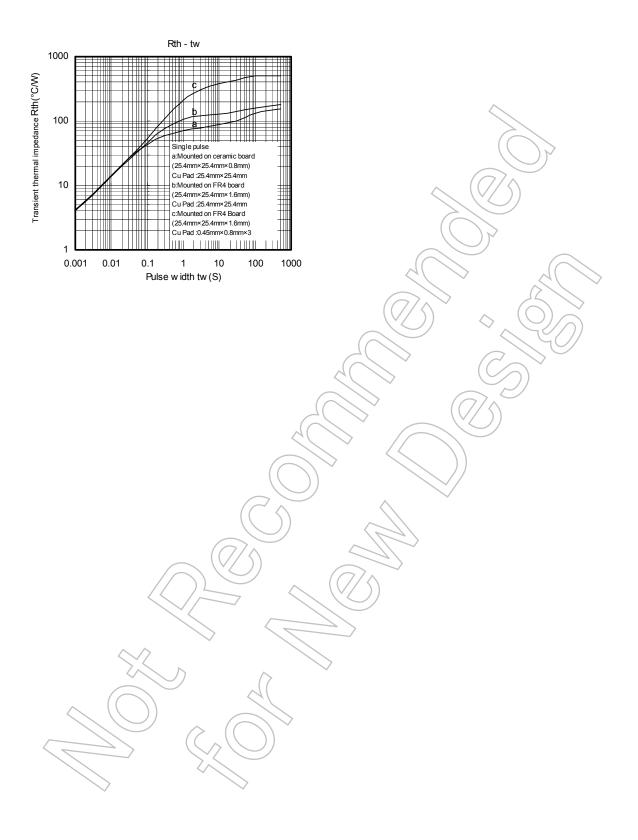












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